TOSHIBA 1200JXH23

TENTATIVE

TOSHIBA FAST RECOVERY DIODE SILICON DIFFUSED TYPE

1 2 0 0 J X H 2 3

HIGH SPEED RECTIFIER APPLICATIONS

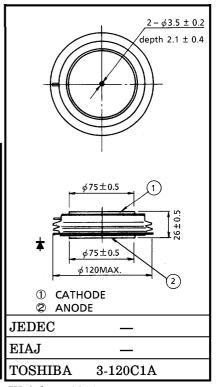
Repetitive Peak Reverse Voltage: V_{RRM} = 6000 V

Average Forward Current $: I_{F(AV)} = 1200 A$

Double Side Cooling

MAXIMUM RATING

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Reverse Voltage	v_{RRM}	6000	V
$\begin{array}{l} \mbox{Non-Repetitive Peak Reverse} \\ \mbox{Voltage (Non-Repetitive} \leq 5 \ \mbox{ms}, \\ \mbox{T}_j \leq 0 {\sim} 125 {\rm ^{\circ}C}) \end{array}$	$v_{ m RSM}$	6300	V
Average Forward Current	I _{F (AV)}	1200	A
Peak One Cycle Surge Forward Current (Non-Repetitive, 10 ms Width Half Sine Waveform)	I_{FSM}	15000	A
Junction Temperature Range	T_{j}	-40~125	°C
Storage Temperature Range	$\mathrm{T_{stg}}$	-40~125	$^{\circ}\mathrm{C}$
Mounting Force	_	37.3 ± 7.8	kN



Unit in mm

Weight: 1300 g

ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	TEST CONDITION	TYP.	MAX	UNIT
Repetitive Peak Reverse Current	I_{RRM}	$V_{ m RRM} = 4500 \ m V, \ T_j = 125 m ^{\circ} C$	_	150	mA
Peak Forward Voltage	V_{FM}	$I_{FM} = 3800 \text{ A}, T_j = 125^{\circ}\text{C}$	_	4.4	V
Reverse Recovery Charge	Q_{rr}	$I_{ m F} = 1200 m A, T_j = 125 ^{\circ} m C \ di_{ m F} / dt = 100 m A / \mu s$	_	4000	μC
Thermal Resistance	$ m R_{th~(j-f)}$	Junction to Fin	_	0.012	°C/W

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